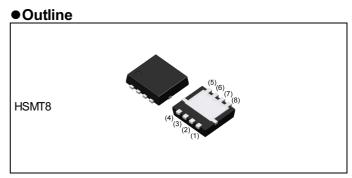


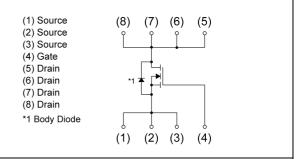
V _{DSS}	100V
R _{DS(on)} (Max.)	15.6mΩ
Ι _D	±40A
P _D	59W

Features

- 1) Low on resistance
- 2) High power package (HSMT8)
- 3) Pb-free plating ; RoHS compliant
- 4) Halogen free
- 5) 100% Rg and UIS tested



Inner circuit



Packaging specifications

		Packing	Embossed Tape
		Reel size (mm)	330
● Application	Туре	Tape width (mm)	12
Switching		Quantity (pcs)	3000
Motor drives		Taping code	TB1
DC/DC converter		Marking	P040BH

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain - Source voltage		V _{DSS}	100	V
Continuous drain current	V _{GS} = 10V	۱ _D *1	±40	А
Pulsed drain current		^{*2}	±160	А
Gate - Source voltage		V _{GSS}	±20	V
Avalanche current, single pulse		I _{AS} *3	20	А
Avalanche energy, single pulse		E _{AS} *3	32	mJ
-		P _D ^{*1}	59	W
Power dissipation		P _D *4	2.0	W
Junction temperature		Тj	150	°C
Operating junction and storage tempe	T _{stg}	-55 to +150	°C	

•Thermal resistance

Deremeter	Sumbol	Values			Linit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC} *1	-	-	2.1	°C/W
Thermal resistance, junction - ambient	R_{thJA}^{*4}	-	-	62.5	°C/W

• Electrical characteristics (T_a = 25°C)

Devenuetor	Symbol Conditions -		Values			1.1:4
Parameter			Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}} I_{D} = 1mA$ referenced to 25°C		62.3	-	mV/°C
Zero gate voltage drain current	I _{DSS}	V _{DS} = 100V, V _{GS} = 0V	-	-	5	μA
Gate - Source leakage current	I _{GSS}	I_{GSS} $V_{GS} = \pm 20V, V_{DS} = 0V$		-	±500	nA
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 1mA$	2.0	-	4.0	V
Gate threshold voltage temperature coefficient	•		-	-4.5	-	mV/°C
Static drain - source	D *5	V _{GS} = 10V, I _D = 40A	-	12.0	15.6	
on - state resistance	${\sf R}_{\sf DS(on)}^{*5}$	V _{GS} = 6V, I _D = 20A	-	15.6	23.3	mΩ
Gate resistance	R _G	-	-	2	-	Ω
Forward Transfer Admittance	Y _{fs} * ⁵			-	-	S

2/10

*1 T_c=25°C, Limited only by maximum temperature allowed.

*2 Pw≤ 10 μ s , Duty cycle≤ 1%

*3 L \simeq 0.1mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_j = 25°C Fig.3-1,3-2

- *4 Mounted on a Cu board (40×40×0.8mm)
- *5 Pulsed

•Electrical characteristics (T_a = 25°C)

Deremeter	Cumph of	Conditions	Values			Lincit
Parameter	Symbol	mbol Conditions		Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V	-	1080	-	
Output capacitance	C _{oss}	V _{DS} = 50V	-	205	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	12	-	
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 50V, V_{GS}$ = 10V	-	19	-	
Rise time	t _r *5	I _D = 20A	-	20	-	
Turn - off delay time	t _{d(off)} *5	$R_L \simeq 2.5\Omega$	-	35	-	ns
Fall time	t _f *5	R _G = 10Ω	-	13	-	

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Sumbol	Conditions		Values			L lucit
Parameter	Symbol Conditions		UNS	Min.	Тур.	Max.	Unit
Total gata abarga	O *5		V _{GS} = 10V	-	16.7	-	
Total gate charge	Q_g^{*5}	Q _g ° V _{DD} ≃ 50V		-	10.9	-	
Gate - Source charge	Q _{gs} *5	I _D = 40A	V _{GS} = 6V	-	3.8	-	nC
Gate - Drain charge	Q _{gd} *5			-	4.4	-	

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Deremeter	Symbol Conditions		Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	I _S *1		-	-	40	А
Pulse forward current	I _{SP} *2	-	-	-	160	А
Forward voltage	V _{SD} *5	V _{GS} = 0V, I _S = 40A	-	-	1.2	V
Reverse recovery time	t _{rr} *5	I _S = 40A, V _{GS} =0V	-	48	-	ns
Reverse recovery charge	Q _{rr} *5	di/dt = 100A/µs	-	109	-	nC



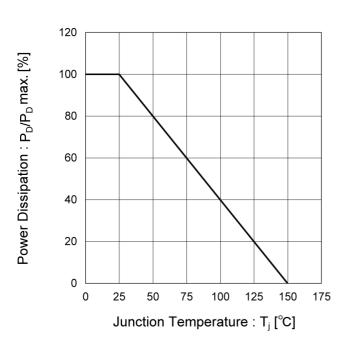


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

Datasheet

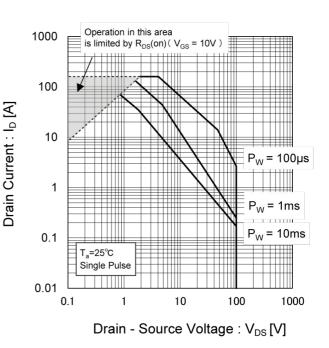
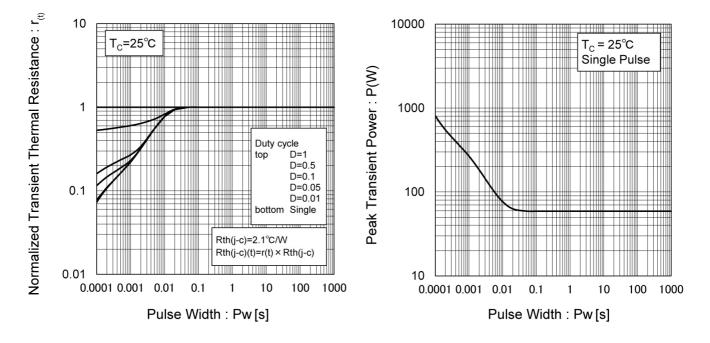


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

Fig.4 Single Pulse Maximum Power Dissipation



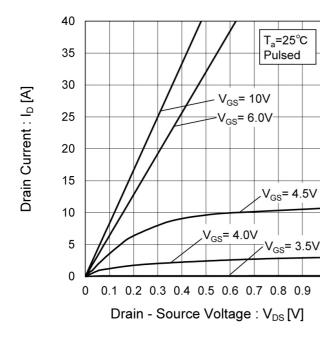


Fig.5 Typical Output Characteristics(I)

Fig.6 Typical Output Characteristics(II)

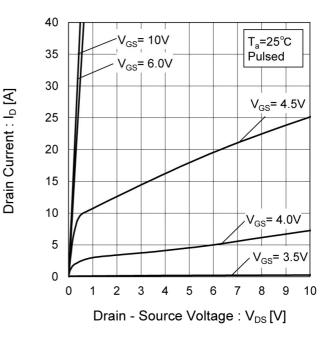
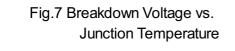
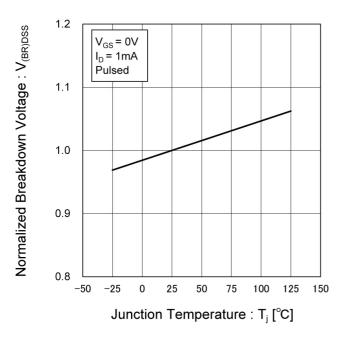


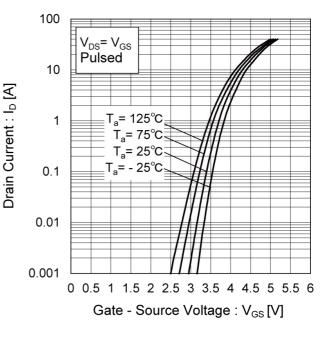
Fig.8 Typical Transfer Characteristics



1

5/10





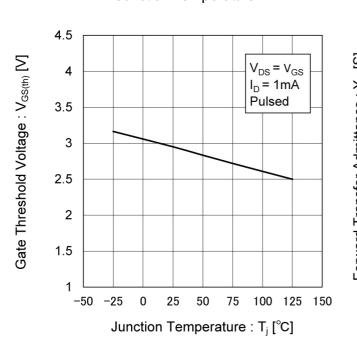


Fig.9 Gate Threshold Voltage vs. Junction Temperature

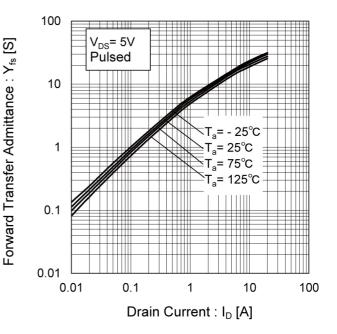


Fig.10 Forward Transfer Admittance vs. Drain Current

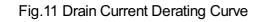
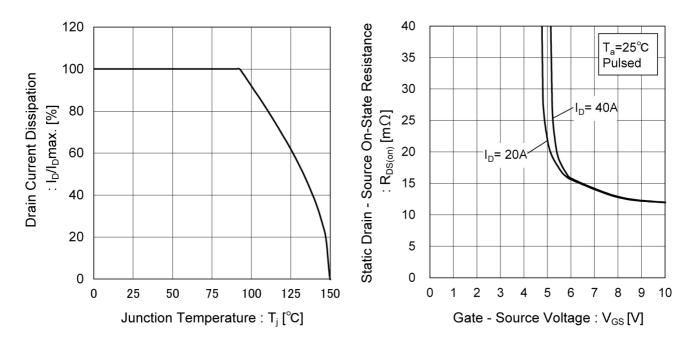


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage





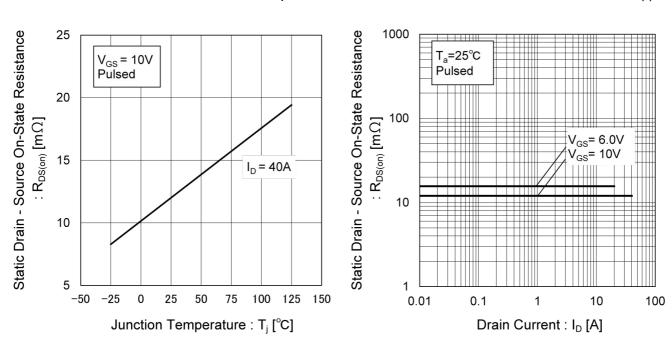


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature Fig.14 Static Drain - Source On - State Resistance vs. Drain Current (I)

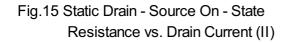
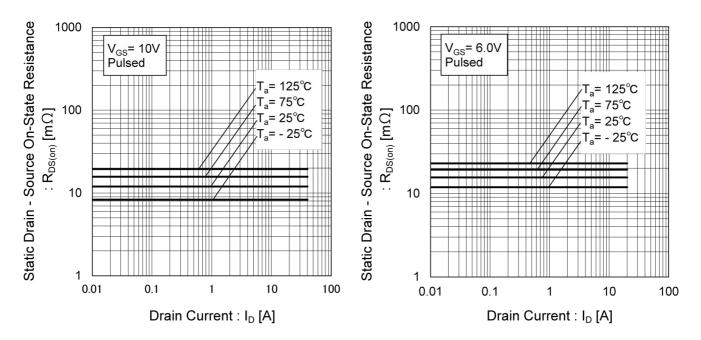


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)



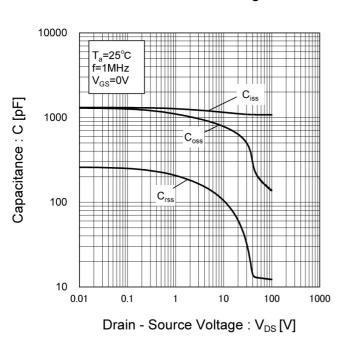


Fig.17 Typical Capacitances vs. Drain - Source Voltage

Fig.18 Switching Characteristics

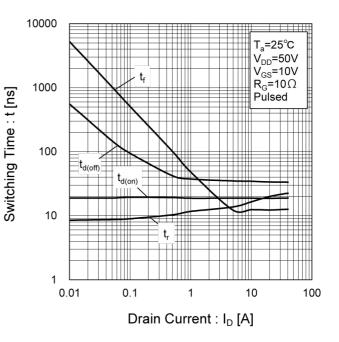


Fig.19 Typical Gate Charge

Gate - Source Voltage : V_{GS} [V]

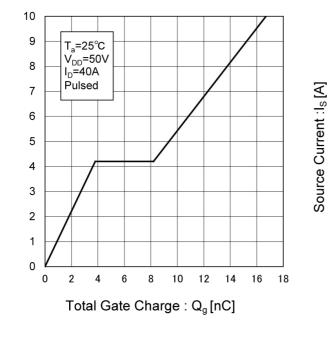
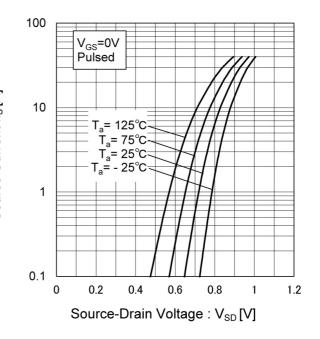
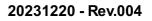


Fig.20 Source Current vs. Source Drain Voltage





Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

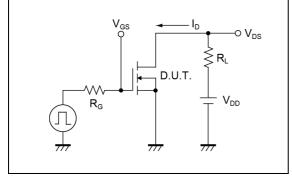


Fig.2-1 Gate Charge Measurement Circuit

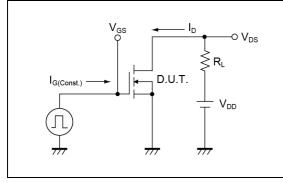


Fig.3-1 Avalanche Measurement Circuit

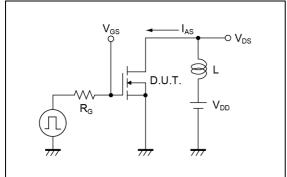


Fig.1-2 Switching Waveforms

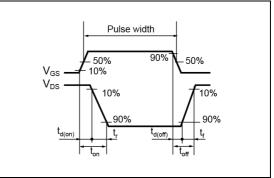


Fig.2-2 Gate Charge Waveform

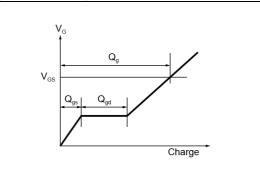
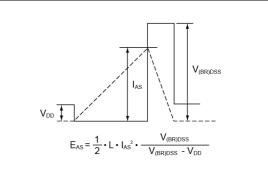


Fig.3-2 Avalanche Waveform



Notice

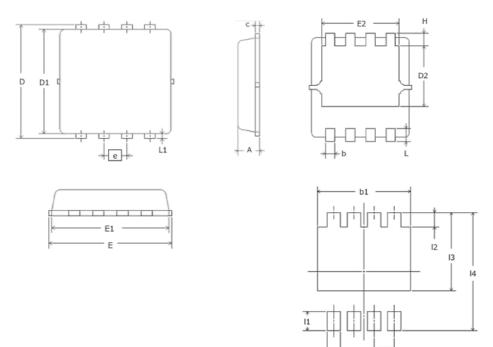
This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.



Dimensions

HSMT8 (TB1)

(3.3x3.3)



e Refarenced footprint dimensions

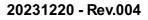
ROHM

b2

	Milimeters		Incl	hes
MID	Min.	Max.	Min.	Max.
A	0.70	0.80	0.028	0.031
b	0.25	0.35	0.010	0.014
с	0.10	0.25	0.004	0.010
D	3.25	3.45	0.128	0.136
D1	3.00	3.20	0.118	0.126
D2	1.78	1.98	0.070	0.078
E	3.20	3.40	0.126	0.134
E1	3.00	3.20	0.118	0.126
E2	2.39	2.59	0.094	0.102
е	0.0	0.65		26
Н	0.30	0.50	0.012	0.020
L	0.30	0.50	0.012	0.020
L1	0.13		0.0	005
	Milimeters		Inc	hes

DIM	Milimeters	Inches
DIM	Nom.	Nom.
11	0.60	0.024
12	0.45	0.018
13	2.45	0.096
14	3.70	0.146
b1	3.00	0.118
b2	0.43	0.017

Dimension in mm/inches



Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (^{Note 1)}, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSI	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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